

ABSTRACT

The problem addressed by the present invention is to provide a technology capable of improving the production yield of molded articles. As a solution, a film (F) is supplied to a die surface of a resin molding die set (10). Next, the film (F) is adhered to the die surface and caused to be in a state of being separated from the die surface at a corner section (13a) of a cavity recess (13). Next, a die set is closed to clamp the film (F). Next, a resin (R) filling the interior of the cavity recess (13) is thermoset, on the film (F) provided therebetween, while adhering the film (f) to the corner section (13a).